

# **LOCTITE STYCAST 1090 CAT 27-1**

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#### PRODUCT DESCRIPTION

LOCTITE STYCAST 1090 CAT 27-1 provides the following product characteristics:

Technology	Ероху		
Appearance (Resin)	Black		
Components	Two components - requires mixing		
Mix Ratio, by weight - Resin : Hardener	100 : 16		
Mix Ratio, by volume - Base : Hardener	100 : 13		
Product Benefits	<ul> <li>Low density syntactic foam</li> <li>Low CTE</li> <li>Low dielectric constant</li> <li>Low shrinkage</li> <li>Good moisture resistance</li> <li>Excellent chemical resistance</li> <li>Good physical strength</li> </ul>		
Cure	Oven Cure		
Application	Encapsulation		
Operating Temperature	-40 to 175 °C		

LOCTITE STYCAST 1090 CAT 27-1 is designed for encapsulation and potting of electronic assemblies that require lower weight such as aerospace applications. LOCTITE STYCAST 1090 CAT 27-1 is also available in the color white.

LOCTITE STYCAST 1090 can be used with a variety of catalysts. For more information on mixed properties when used with other available catalysts, please contact your local technical service representative for assistance and recommendations.

# TYPICAL PROPERTIES OF UNCURED MATERIAL

# Part A Properties LOCTITE STYCAST 1090

Viscosity, Brookfield , 25 °C, mPa·s (cP):

Speed 10 rpm, # 7

Specific Gravity

Shelf Life @ 25°C, months

12

Flash Point - See SDS

## Part B Properties LOCTITE CAT 27-1

Viscosity @ 25 °C, mPa·s (cP) 250 to 300

Flash Point - See SDS

#### **Mixed Properties**

Mixed Density, g/cm³ 0.827 Flash Point - See SDS

## **TYPICAL CURING PERFORMANCE**

#### **Cure Schedule**

Convection Box Oven: 4 hours @ 120°C

The above cure profile is a guideline recommendation. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

# TYPICAL PROPERTIES OF CURED MATERIAL

# **Physical Properties**

Density, g/cm³	0.849
Coefficient of Thermal Expansion, TMA: Below Tg, µm/(m.°C) Above Tg, µm/(m.°C)	45 122
Glass Transition Temperature, °C:	
(Tg) by DMA @ tan delta	129
(Tg) by TMA	83
Thermal Conductivity, W/(m-K)	0.18
Hardness, Shore D	80
Volume Shrinkage on Cure, %	2.7
Linear Shrinkage, %	0.9
Water Absorption, %:	
1 day @ 25°C	0.07
1 week @ 25°C	0.3

#### Young's modulus (E):

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@ -4	10°C	N/mm²	2,138
		(psi)	(310,000)
@ 0	°C	N/mm²	2,038
		(psi)	(296,000)
@ 2	5°C	$N/mm^2$	2,001
		(psi)	(290,000)
@ 5	0°C	$N/mm^2$	1,962
		(psi)	(285,000)
@ 10	00°C	$N/mm^2$	1,596
		(psi)	(231,000)
@ 1	50°C	N/mm²	48
		(psi)	(6.960)



### **Electrical Properties**

Volume Resistivity, ohm-cm	1.8×10 <sup>15</sup>
Surface Resistivity, ohms	9.3×10 <sup>13</sup>
Dielectric Strength, kV/mm	24
Dielectric Constant / Dissipation Factor :	
@ 50 Hz	3.2/0.124
@ 1 kHz	3 0/0 032

@ 50 Hz	3.2/0.124
@ 1 kHz	3.0/0.032
@ 1 MHz	2.7/0.023

#### **GENERAL INFORMATION**

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

#### **DIRECTIONS FOR USE**

- Complete cleaning of the substrates should be performed to remove contamination such as oxide layers, dust, moisture, salt and oils which can cause poor adhesion or corrosion in a bonded part.
- Some separation of components is common during shipping and storage. For this reason, it is recommended that the contents of the shipping container be thoroughly mixed prior to use.
- 3. Accurately weigh resin and hardener into a clean container in the recommended ratio.
- 4. Blend components by hand, using a kneading motion, for 2 to 3 minutes. Scrape the bottom and sides of the mixing container frequently to produce a uniform mixture.
- If possible, power mix for an additional 2 to 3 minutes. Avoid high mixing speeds. This can entrap excessive amounts of air. It can also cause overheating of the mixture, resulting in reduced working life.
- 6. To ensure a void-free embedment, vacuum deairing should be used to remove any entrapped air introduced during the mixing operation.
- Pump-down or pull vacuum on the mixture to achieve an ultimate vacuum or absolute pressure of 1 to 5 torr or mm Hg. The foam will rise several times in the liquid height and then subside.
- 8. Continue vacuum deairing until most of the bubbling has ceased. This usually takes 3 to 10 minutes.
- To facilitate deairing in difficult to deair materials, add a few drops of an air release agent, such as ANTIFOAM 88 into 100 grams of mixture.
- Gentle warming will also help, but pot life will be shortened.
- 11. Pour mixture into cavity or mold.
- 12. Gentle warming of the mold or assembly reduces the viscosity. This improves the flow of the material into the unit having intricate shapes or tightly packed coils or components.
- Further vacuum deairing in the mold may be required for critical applications.

#### STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

# Optimal Storage: 25 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Certain resins and hardeners are prone to crystallization. If crystallization does occur, warm the contents of the shipping container to 50 to 60°C until all crystals have dissolved. Be sure the shipping container is loosely covered during the warming stage to prevent any pressure build-up. Allow contents to cool to room temperature before continuing.

#### Conversions

(°C x 1.8) + 32 = °F kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb/F N/mm x 5.71 = lb/in psi x 145 = N/mm² MPa = N/mm² N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

# **Disclaimer**

#### Note:

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